

# 30 V, 400 mA N-channel Trench MOSFET Rev. 1 — 2 August 2011

Product data sheet

#### **Product profile** 1.

#### 1.1 General description

N-channel enhancement mode Field-Effect Transistor (FET) in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

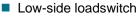
#### 1.2 Features and benefits

- Very fast switching
- Low threshold voltage
- Trench MOSFET technology

#### 1.3 Applications

- Relay driver
- High-speed line driver

- ESD protection up to 2 kV
- AEC-Q101 qualified



Switching circuits

#### 1.4 Quick reference data

#### Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C	-	-	30	V
V <sub>GS</sub>	gate-source voltage		-8	-	8	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = 4.5 V; T <sub>amb</sub> = 25 °C	<u>[1]</u> _	-	400	mA
Static cha	aracteristics					
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 4.5 V; I <sub>D</sub> = 350 mA; T <sub>i</sub> = 25 °C	-	1	1.4	Ω

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 1 cm<sup>2</sup>.



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### 2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		2
2	S	source		D
3	D	drain	1 ☐ ☐ 2 SOT23 (TO-236AB)	G S 017aea255

### 3. Ordering information

Table 3.	Ordering in	formation		
Type number Package		Package		
		Name	Description	Version
NX3008NE	К	TO-236AB	plastic surface-mounted package; 3 leads	SOT23

### 4. Marking

Table 4. Marking codes	
Type number	Marking code <sup>[1]</sup>
NX3008NBK	KS%

[1] % = placeholder for manufacturing site code.

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### 5. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C	-	30	V
V <sub>GS</sub>	gate-source voltage		-8	8	V
I <sub>D</sub>	drain current	$V_{GS}$ = 4.5 V; $T_{amb}$ = 25 °C	<u>[1]</u> _	400	mA
		$V_{GS}$ = 4.5 V; $T_{amb}$ = 100 °C	<u>[1]</u> _	250	mA
I <sub>DM</sub>	peak drain current	$T_{amb} = 25 \text{ °C}$ ; single pulse; $t_p \le 10 \mu\text{s}$	-	1.6	А
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C	[2] _	350	mW
			<u>[1]</u> _	420	mW
		T <sub>sp</sub> = 25 °C	-	1140	mW
Tj	junction temperature		-55	150	°C
T <sub>amb</sub>	ambient temperature		-55	150	°C
T <sub>stg</sub>	storage temperature		-65	150	°C
Source-drain	diode				
Is	source current	T <sub>amb</sub> = 25 °C	<u>[1]</u> _	400	mA
ESD maximu	im rating				
V <sub>ESD</sub>	electrostatic discharge voltage	HBM	[3]	2000	V

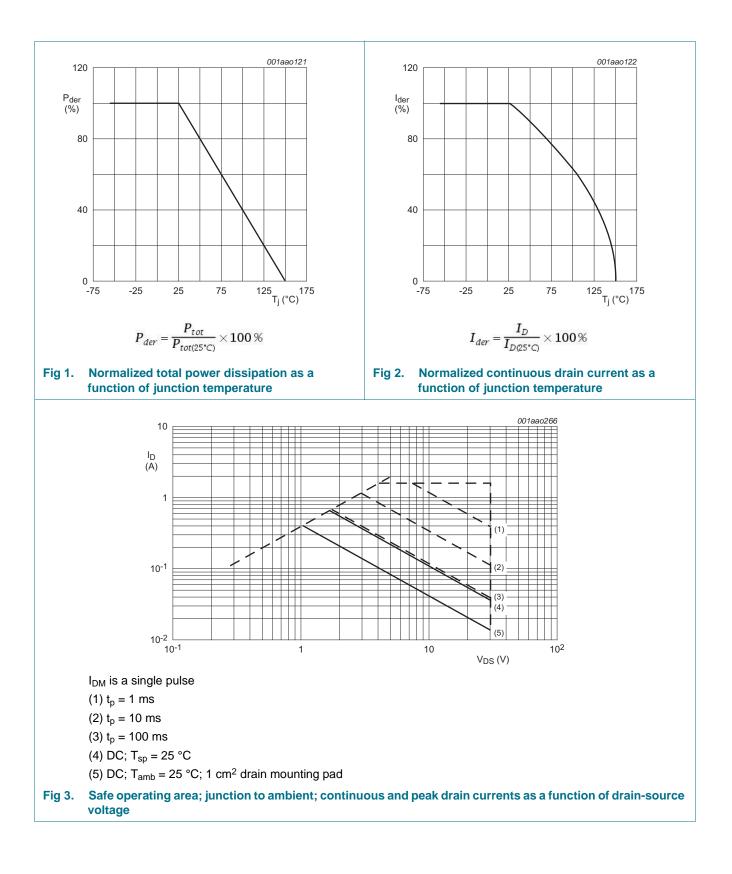
[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 1 cm<sup>2</sup>.

[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[3] Measured between all pins.

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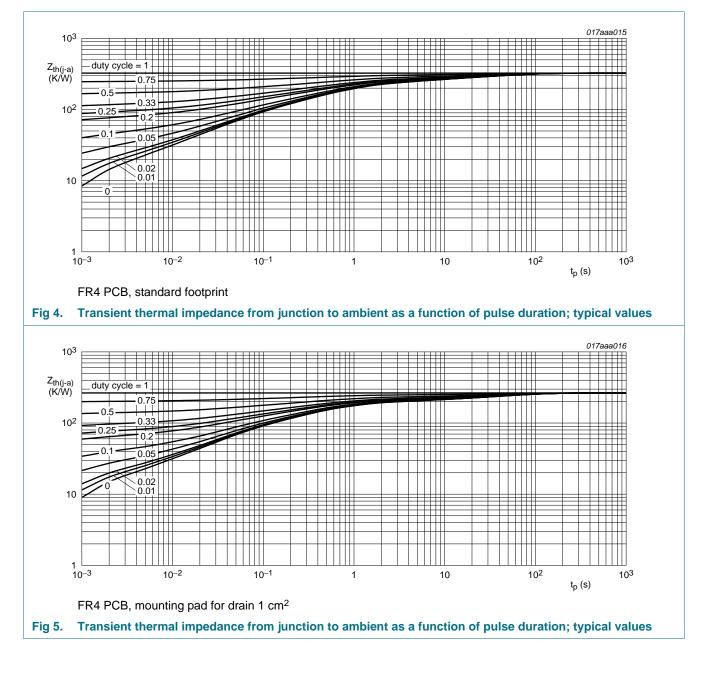
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#### **Thermal characteristics** 6.

Table 6.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	<u>[1]</u> _	310	370	K/W
			[2] _	260	300	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		-	-	115	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 1 cm<sup>2</sup>.



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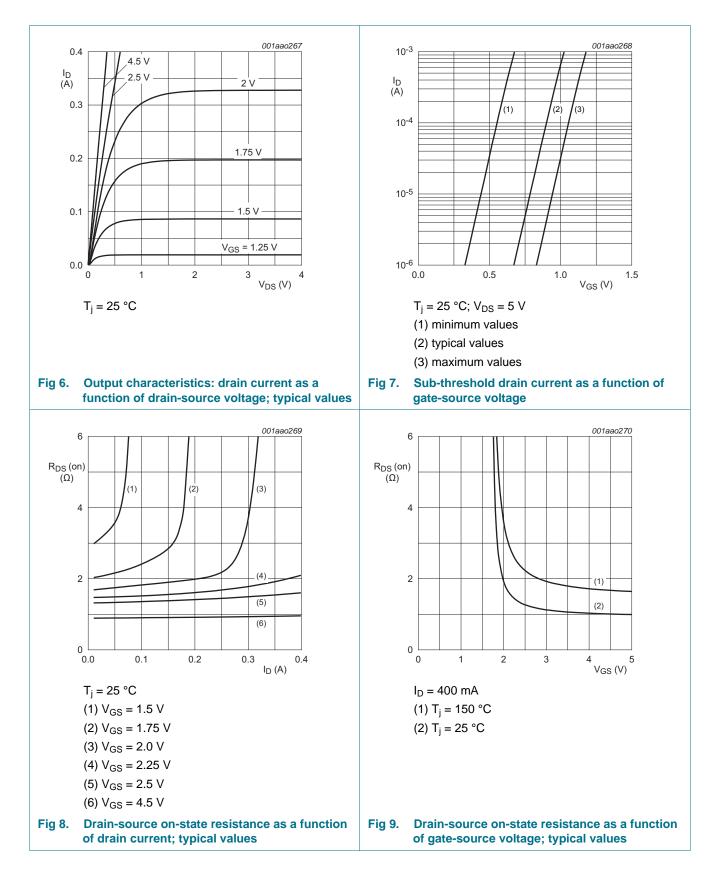
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### 7. Characteristics

Table 7.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics					
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	$I_D = 250 \ \mu\text{A}; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^\circ\text{C}$	30	-	-	V
V <sub>GSth</sub>	gate-source threshold voltage	$I_D = 250 \ \mu A; \ V_{DS} = V_{GS}; \ T_j = 25 \ ^{\circ}C$	0.6	0.9	1.1	V
I <sub>DSS</sub>	drain leakage current	$V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	-	1	μΑ
		$V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 150 \text{ °C}$	-	-	10	μΑ
I <sub>GSS</sub>	gate leakage current	$V_{GS} = 8 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	0.2	1	μΑ
		$V_{GS} = -8 \text{ V}; V_{DS} = 0 \text{ V}; \text{ T}_{j} = 25 \text{ °C}$	-	0.2	1	μΑ
		$V_{GS} = 4.5 \text{ V}; V_{DS} = 0 \text{ V}; \text{ T}_{j} = 25 \text{ °C}$	-	10	-	nA
		$V_{GS}$ = -4.5 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	10	-	nA
		$V_{GS}$ = 2.5 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	1	-	nA
		$V_{GS}$ = -2.5 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	1	-	nA
R <sub>DSon</sub>	drain-source on-state resistance	$V_{GS}$ = 4.5 V; I <sub>D</sub> = 350 mA; T <sub>j</sub> = 25 °C	-	1	1.4	Ω
		$V_{GS}$ = 4.5 V; I <sub>D</sub> = 350 mA; T <sub>j</sub> = 150 °C	-	1.8	2.5	Ω
		$V_{GS}$ = 2.5 V; I <sub>D</sub> = 200 mA; T <sub>j</sub> = 25 °C	-	1.4	2.1	Ω
		$V_{GS}$ = 1.8 V; I <sub>D</sub> = 10 mA; T <sub>j</sub> = 25 °C	-	2	2.8	Ω
9 <sub>fs</sub>	forward transconductance	$V_{DS}$ = 10 V; I <sub>D</sub> = 350 mA; T <sub>j</sub> = 25 °C	-	310	-	mS
Dynamic	characteristics					
Q <sub>G(tot)</sub>	total gate charge	$V_{DS}$ = 15 V; I <sub>D</sub> = 400 mA; V <sub>GS</sub> = 4.5 V;	-	0.52	0.68	nC
Q <sub>GS</sub>	gate-source charge	T <sub>j</sub> = 25 °C	-	0.17	-	nC
Q <sub>GD</sub>	gate-drain charge		-	0.08	-	nC
C <sub>iss</sub>	input capacitance	$V_{DS}$ = 15 V; f = 1 MHz; $V_{GS}$ = 0 V;	-	34	50	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C	-	6.5	-	pF
C <sub>rss</sub>	reverse transfer capacitance		-	2.2	-	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS}$ = 20 V; $R_L$ = 250 $\Omega$ ; $V_{GS}$ = 4.5 V;	-	15	30	ns
t <sub>r</sub>	rise time	R <sub>G(ext)</sub> = 6 Ω; T <sub>j</sub> = 25 °C	-	11	-	ns
t <sub>d(off)</sub>	turn-off delay time		-	69	138	ns
t <sub>f</sub>	fall time		-	19	-	ns
Source-d	rain diode					
V <sub>SD</sub>	source-drain voltage	I <sub>S</sub> = 350 mA; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	0.47	0.85	1.2	V

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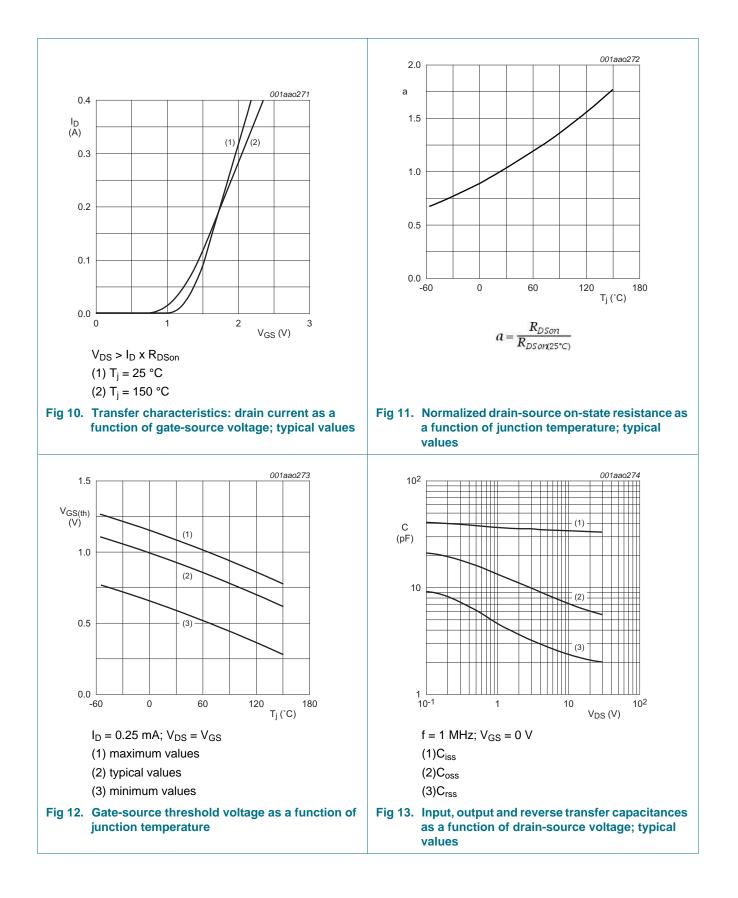


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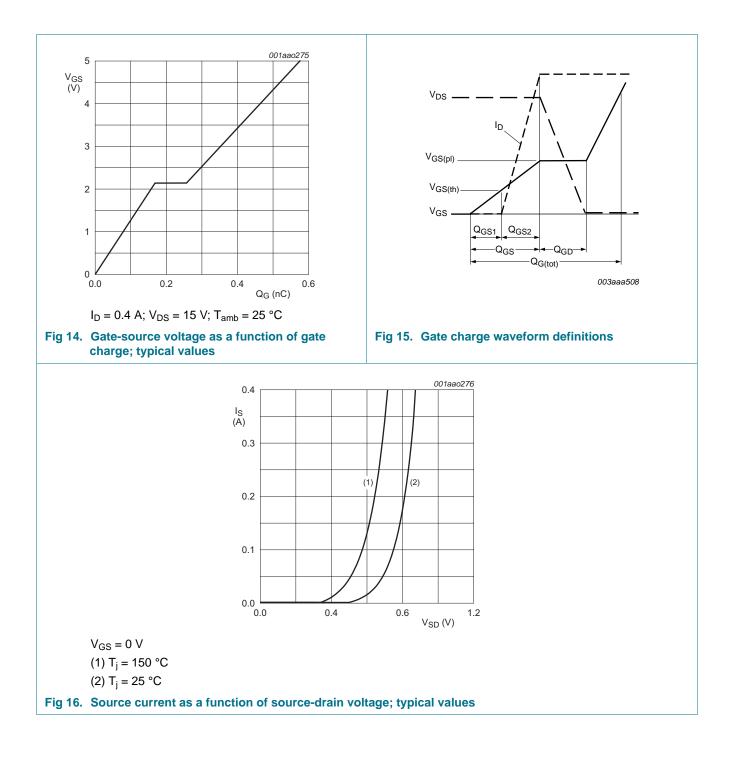
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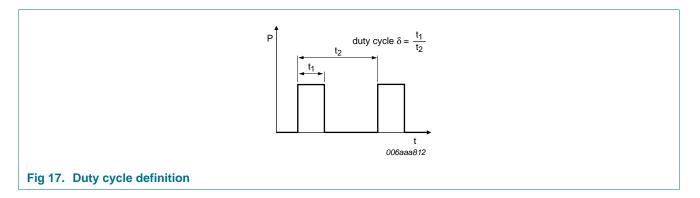
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### 8. Test information



#### 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

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#### 9. Package outline

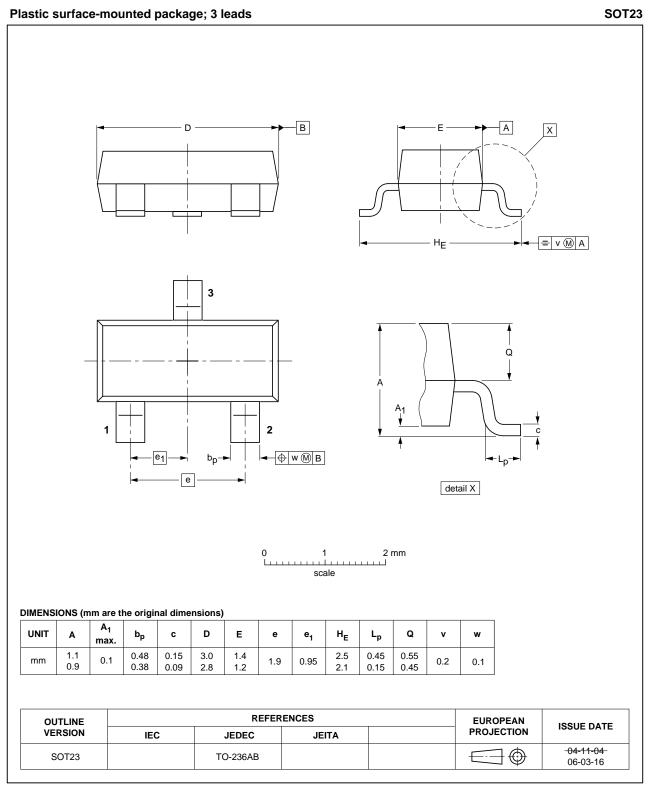
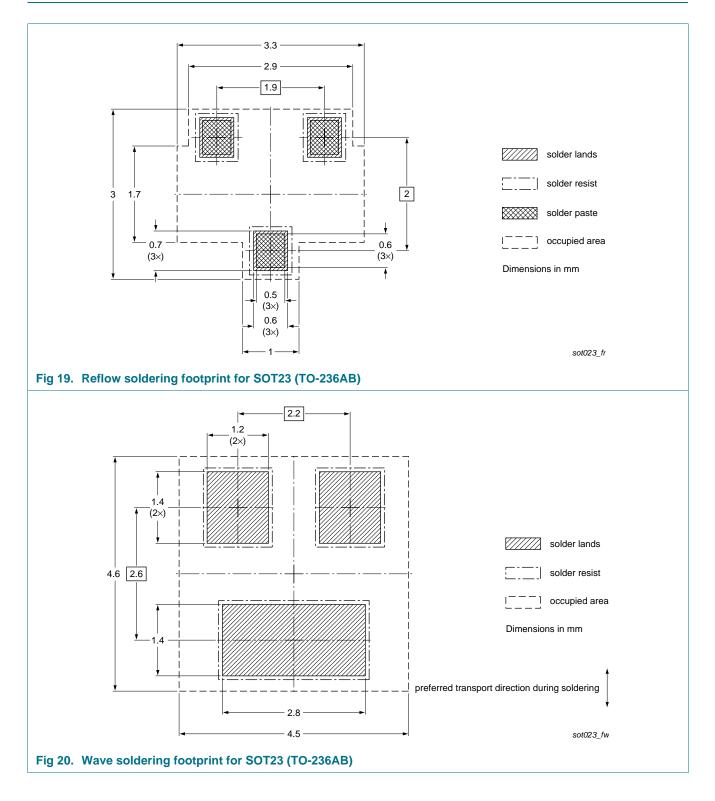


Fig 18. Package outline SOT23 (TO-236AB)

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### **10. Soldering**



### **11. Revision history**

Table 8.	Revision history						
Document	ID	Release date	Data sheet status	Change notice	Supersedes		
NX3008NB	K v.1	20110802	Product data sheet	-	-		

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### **12. Legal information**

#### **12.1 Data sheet status**

Document status [1] [2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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